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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Obsolete
Number of LABs/CLBs	4964
Number of Logic Elements/Cells	118143
Total RAM Bits	8315904
Number of I/O	260
Number of Gates	-
Voltage - Supply	0.87V ~ 0.93V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	572-BGA, FCBGA
Supplier Device Package	572-FBGA, FC (25x25)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/ep2agx125df25c6n">https://www.e-xfl.com/product-detail/intel/ep2agx125df25c6n</a>

**Table 1–6. Recommended Operating Conditions for Arria II GZ Devices (*Note 6*) (Part 2 of 2)**

Symbol	Description	Condition	Minimum	Typical	Maximum	Unit
$V_{CCL\_GXBLn}$ <i>(3)</i>	Transceiver clock power (left side)	—	1.05	1.1	1.15	V
$V_{CCL\_GXBRn}$ <i>(3)</i>	Transceiver clock power (right side)	—	1.05	1.1	1.15	V
$V_{CCH\_GXBLn}$ <i>(3)</i>	Transmitter output buffer power (left side)	—				
$V_{CCH\_GXBRn}$ <i>(3)</i>	Transmitter output buffer power (right side)	—	1.33/1.425	1.4/1.5 <i>(5)</i>	1.575	V
$T_J$	Operating junction temperature	Commercial	0	—	85	°C
		Industrial	-40	—	100	°C
$t_{RAMP}$	Power supply ramp time	Normal POR (PORSEL=0)	0.05	—	100	ms
		Fast POR (PORSEL=1)	0.05	—	4	ms

**Notes to Table 1–6:**

- (1) Altera recommends a 3.0-V nominal battery voltage when connecting  $V_{CCBAT}$  to a battery for volatile key backup. If you do not use the volatile security key, you may connect the  $V_{CCBAT}$  to either GND or a 3.0-V power supply.
- (2)  $V_{CCPD}$  must be 2.5 V when  $V_{CCIO}$  is 2.5, 1.8, 1.5, or 1.2 V.  $V_{CCPD}$  must be 3.0 V when  $V_{CCIO}$  is 3.0 V.
- (3)  $n = 0, 1,$  or  $2.$
- (4)  $V_{CCA\_L/R}$  must be connected to a 3.0-V supply if the clock multiplier unit (CMU) phase-locked loop (PLL), receiver clock data recovery (CDR), or both, are configured at a base data rate > 4.25 Gbps. For data rates up to 4.25 Gbps, you can connect  $V_{CCA\_L/R}$  to either 3.0 V or 2.5 V.
- (5)  $V_{CCH\_GXBL/R}$  must be connected to a 1.4-V supply if the transmitter channel data rate is > 6.5 Gbps. For data rates up to 6.5 Gbps, you can connect  $V_{CCH\_GXBL/R}$  to either 1.4 V or 1.5 V.
- (6) Transceiver power supplies do not have power-on-reset (POR) circuitry. After initial power-up, violating the transceiver power supply operating conditions could lead to unpredictable link behavior.

## DC Characteristics

This section lists the supply current, I/O pin leakage current, on-chip termination (OCT) accuracy and variation, input pin capacitance, internal weak pull-up and pull-down resistance, hot socketing, and Schmitt trigger input specifications.

### Supply Current

Standby current is the current the device draws after the device is configured with no inputs or outputs toggling and no activity in the device. Because these currents vary largely with the resources used, use the Microsoft Excel-based Early Power Estimator (EPE) to get supply current estimates for your design.

 For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter.

Table 1–10 lists the bus hold specifications for Arria II GZ devices.

**Table 1–10. Bus Hold Parameters for Arria II GZ Devices**

<b>Parameter</b>	<b>Symbol</b>	<b>Cond.</b>	<b>V<sub>CCIO</sub> (V)</b>										<b>Unit</b>	
			<b>1.2</b>		<b>1.5</b>		<b>1.8</b>		<b>2.5</b>		<b>3.0</b>			
			<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>		
Bus-hold Low sustaining current	I <sub>SUSL</sub>	V <sub>IN</sub> > V <sub>IL</sub> (max.)	22.5	—	25.0	—	30.0	—	50.0	—	70.0	—	μA	
Bus-hold High sustaining current	I <sub>SUSH</sub>	V <sub>IN</sub> < V <sub>IH</sub> (min.)	-22.5	—	-25.0	—	-30.0	—	-50.0	—	-70.0	—	μA	
Bus-hold Low overdrive current	I <sub>ODL</sub>	0V < V <sub>IN</sub> < V <sub>CCIO</sub>	—	120	—	160	—	200	—	300	—	500	μA	
Bus-hold High overdrive current	I <sub>ODH</sub>	0V < V <sub>IN</sub> < V <sub>CCIO</sub>	—	-120	—	-160	—	-200	—	-300	—	-500	μA	
Bus-hold trip point	V <sub>TRIP</sub>	—	0.45	0.95	0.50	1.00	0.68	1.07	0.70	1.70	0.80	2.00	V	

### OCT Specifications

Table 1–11 lists the Arria II GX device and differential OCT with and without calibration accuracy.

**Table 1–11. OCT With and Without Calibration Specification for Arria II GX Device I/Os (Note 1) (Part 1 of 2)**

<b>Symbol</b>	<b>Description</b>	<b>Conditions (V)</b>	<b>Calibration Accuracy</b>		<b>Unit</b>
			<b>Commercial</b>	<b>Industrial</b>	
25-Ω R <sub>S</sub> 3.0, 2.5	25-Ω series OCT without calibration	V <sub>CCIO</sub> = 3.0, 2.5	± 30	± 40	%
50-Ω R <sub>S</sub> 3.0, 2.5	50-Ω series OCT without calibration	V <sub>CCIO</sub> = 3.0, 2.5	± 30	± 40	%
25-Ω R <sub>S</sub> 1.8	25-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.8	± 40	± 50	%
50-Ω R <sub>S</sub> 1.8	50-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.8	± 40	± 50	%
25-Ω R <sub>S</sub> 1.5, 1.2	25-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.5, 1.2	± 50	± 50	%
50-Ω R <sub>S</sub> 1.5, 1.2	50-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.5, 1.2	± 50	± 50	%
25-Ω R <sub>S</sub> 3.0, 2.5, 1.8, 1.5, 1.2	25-Ω series OCT with calibration	V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2	± 10	± 10	%

**Table 1–11. OCT With and Without Calibration Specification for Arria II GX Device I/Os (*Note 1*) (Part 2 of 2)**

<b>Symbol</b>	<b>Description</b>	<b>Conditions (V)</b>	<b>Calibration Accuracy</b>		<b>Unit</b>
			<b>Commercial</b>	<b>Industrial</b>	
50- $\Omega$ $R_S$ 3.0, 2.5, 1.8, 1.5, 1.2	50- $\Omega$ series OCT with calibration	$V_{CCIO} = 3.0, 2.5,$ 1.8, 1.5, 1.2	$\pm 10$	$\pm 10$	%
100- $\Omega$ $R_D$ 2.5	100- $\Omega$ differential OCT without calibration	$V_{CCIO} = 2.5$	$\pm 30$	$\pm 30$	%

**Note to Table 1–11:**

- (1) OCT with calibration accuracy is valid at the time of calibration only.

**Table 1–12** lists the OCT termination calibration accuracy specifications for Arria II GZ devices.

**Table 1–12. OCT with Calibration Accuracy Specifications for Arria II GZ Devices (*Note 1*)**

<b>Symbol</b>	<b>Description</b>	<b>Conditions (V)</b>	<b>Calibration Accuracy</b>			<b>Unit</b>
			<b>C2</b>	<b>C3,I3</b>	<b>C4,I4</b>	
25- $\Omega$ $R_S$ 3.0, 2.5, 1.8, 1.5, 1.2 <b>(2)</b>	25- $\Omega$ series OCT with calibration	$V_{CCIO} = 3.0, 2.5,$ 1.8, 1.5, 1.2	$\pm 8$	$\pm 8$	$\pm 8$	%
50- $\Omega$ $R_S$ 3.0, 2.5, 1.8, 1.5, 1.2	50- $\Omega$ internal series OCT with calibration	$V_{CCIO} = 3.0, 2.5,$ 1.8, 1.5, 1.2	$\pm 8$	$\pm 8$	$\pm 8$	%
50- $\Omega$ $R_T$ 2.5, 1.8, 1.5, 1.2	50- $\Omega$ internal parallel OCT with calibration	$V_{CCIO} = 2.5, 1.8,$ 1.5, 1.2	$\pm 10$	$\pm 10$	$\pm 10$	%
20- $\Omega$ , 40- $\Omega$ , and 60- $\Omega$ $R_S$ 3.0, 2.5, 1.8, 1.5, 1.2 <b>(3)</b>	20- $\Omega$ , 40- $\Omega$ and 60- $\Omega$ $R_S$ expanded range for internal series OCT with calibration	$V_{CCIO} = 3.0, 2.5,$ 1.8, 1.5, 1.2	$\pm 10$	$\pm 10$	$\pm 10$	%
25- $\Omega$ $R_{S\_left\_shift}$ 3.0, 2.5, 1.8, 1.5, 1.2	25- $\Omega$ $R_{S\_left\_shift}$ internal left shift series OCT with calibration	$V_{CCIO} = 3.0, 2.5,$ 1.8, 1.5, 1.2	$\pm 10$	$\pm 10$	$\pm 10$	%

**Notes to Table 1–12:**

- (1) OCT calibration accuracy is valid at the time of calibration only.  
 (2) 25- $\Omega$   $R_S$  is not supported for 1.5 V and 1.2 V in Row I/O.  
 (3) 20- $\Omega$   $R_S$  is not supported for 1.5 V and 1.2 V in Row I/O.

Use the following with [Equation 1-1](#):

- $R_{SCAL}$  is the OCT resistance value at power up.
- $\Delta T$  is the variation of temperature with respect to the temperature at power up.
- $\Delta V$  is the variation of voltage with respect to the  $V_{CCIO}$  at power up.
- $dR/dT$  is the percentage change of  $R_{SCAL}$  with temperature.
- $dR/dV$  is the percentage change of  $R_{SCAL}$  with voltage.

[Table 1-14](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GX devices.

**Table 1-14. OCT Variation after Power-up Calibration for Arria II GX Devices**

Nominal Voltage $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.262	0.035
2.5	0.234	0.039
1.8	0.219	0.086
1.5	0.199	0.136
1.2	0.161	0.288

[Table 1-15](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GZ devices.

**Table 1-15. OCT Variation after Power-Up Calibration for Arria II GZ Devices (Note 1)**

Nominal Voltage, $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.189	0.0297
2.5	0.208	0.0344
1.8	0.266	0.0499
1.5	0.273	0.0744
1.2	0.317	0.1241

#### Note to Table 1-15:

(1) Valid for  $V_{CCIO}$  range of  $\pm 5\%$  and temperature range of 0° to 85°C.

#### Pin Capacitance

[Table 1-16](#) lists the pin capacitance for Arria II GX devices.

**Table 1-16. Pin Capacitance for Arria II GX Devices**

Symbol	Description	Typical	Unit
$C_{IO}$	Input capacitance on I/O pins, dual-purpose pins (differential I/O, clock, $R_{up}$ , $R_{dn}$ ), and dedicated clock input pins	7	pF

**Table 1–23. Single-Ended I/O Standards for Arria II GZ Devices (Part 2 of 2)**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>IL</sub> (V)		V <sub>IH</sub> (V)		V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
1.2 V	1.14	1.2	1.26	-0.3	0.35 × V <sub>CCIO</sub>	0.65 × V <sub>CCIO</sub>	V <sub>CCIO</sub> + 0.3	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	2	-2
3.0-V PCI	2.85	3	3.15	—	0.3 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	3.6	0.1 × V <sub>CCIO</sub>	0.9 × V <sub>CCIO</sub>	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	0.35 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	—	0.1 × V <sub>CCIO</sub>	0.9 × V <sub>CCIO</sub>	1.5	-0.5

Table 1–24 lists the single-ended SSTL and HSTL I/O reference voltage specifications for Arria II GX devices.

**Table 1–24. Single-Ended SSTL and HSTL I/O Reference Voltage Specifications for Arria II GX Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>REF</sub> (V)			V <sub>TT</sub> (V)		
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.49 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.51 × V <sub>CCIO</sub>	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-18 Class I, II	1.71	1.8	1.89	0.833	0.9	0.969	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-15 Class I, II	1.425	1.5	1.575	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>
HSTL-18 Class I, II	1.71	1.8	1.89	0.85	0.9	0.95	0.85	0.9	0.95
HSTL-15 Class I, II	1.425	1.5	1.575	0.71	0.75	0.79	0.71	0.75	0.79
HSTL-12 Class I, II	1.14	1.2	1.26	0.48 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.52 × V <sub>CCIO</sub>	—	V <sub>CCIO</sub> /2	—

Table 1–25 lists the single-ended SSTL and HSTL I/O reference voltage specifications for Arria II GZ devices.

**Table 1–25. Single-Ended SSTL and HSTL I/O Reference Voltage Specifications for Arria II GZ Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>REF</sub> (V)			V <sub>TT</sub> (V)		
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.49 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.51 × V <sub>CCIO</sub>	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-18 Class I, II	1.71	1.8	1.89	0.833	0.9	0.969	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-15 Class I, II	1.425	1.5	1.575	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>	0.47 × V <sub>CCIO</sub>	V <sub>REF</sub>	0.53 × V <sub>CCIO</sub>
HSTL-18 Class I, II	1.71	1.8	1.89	0.85	0.9	0.95	—	V <sub>CCIO</sub> /2	—
HSTL-15 Class I, II	1.425	1.5	1.575	0.68	0.75	0.9	—	V <sub>CCIO</sub> /2	—
HSTL-12 Class I, II	1.14	1.2	1.26	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>	—	V <sub>CCIO</sub> /2	—

**Table 1–26** lists the single-ended SSTL and HSTL I/O standard signal specifications for Arria II GX devices.

**Table 1–26. Single-Ended SSTL and HSTL I/O Standard Signal Specifications for Arria II GX Devices**

I/O Standard	V <sub>IL(DC)</sub> (V)		V <sub>IH(DC)</sub> (V)		V <sub>IL(AC)</sub> (V)	V <sub>IH(AC)</sub> (V)	V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)
	Min	Max	Min	Max	Max	Min	Max	Min		
SSTL-2 Class I	-0.3	V <sub>REF</sub> - 0.18	V <sub>REF</sub> + 0.18	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.35	V <sub>REF</sub> + 0.35	V <sub>TT</sub> - 0.57	V <sub>TT</sub> + 0.57	8.1	-8.1
SSTL-2 Class II	-0.3	V <sub>REF</sub> - 0.18	V <sub>REF</sub> + 0.18	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.35	V <sub>REF</sub> + 0.35	V <sub>TT</sub> - 0.76	V <sub>TT</sub> + 0.76	16.4	-16.4
SSTL-18 Class I	-0.3	V <sub>REF</sub> - 0.125	V <sub>REF</sub> + 0.125	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.25	V <sub>REF</sub> + 0.25	V <sub>TT</sub> - 0.475	V <sub>TT</sub> + 0.475	6.7	-6.7
SSTL-18 Class II	-0.3	V <sub>REF</sub> - 0.125	V <sub>REF</sub> + 0.125	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.25	V <sub>REF</sub> + 0.25	0.28	V <sub>CCIO</sub> - 0.28	13.4	-13.4
SSTL-15 Class I	-0.3	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.175	V <sub>REF</sub> + 0.175	0.2 × V <sub>CCIO</sub>	0.8 × V <sub>CCIO</sub>	8	-8
SSTL-15 Class II	-0.3	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.175	V <sub>REF</sub> + 0.175	0.2 × V <sub>CCIO</sub>	0.8 × V <sub>CCIO</sub>	16	-16
HSTL-18 Class I	-0.3	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	8	-8
HSTL-18 Class II	-0.3	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	16	-16
HSTL-15 Class I	-0.3	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	8	-8
HSTL-15 Class II	-0.3	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	16	-16
HSTL-12 Class I	-0.15	V <sub>REF</sub> - 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	8	-8
HSTL-12 Class II	-0.15	V <sub>REF</sub> - 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	14	-14

**Table 1–27** lists the single-ended SSTL and HSTL I/O standard signal specifications for Arria II GZ devices.

**Table 1–27. Single-Ended SSTL and HSTL I/O Standards Signal Specifications for Arria II GZ Devices (Part 1 of 2)**

I/O Standard	V <sub>IL(DC)</sub> (V)		V <sub>IH(DC)</sub> (V)		V <sub>IL(AC)</sub> (V)	V <sub>IH(AC)</sub> (V)	V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)
	Min	Max	Min	Max	Max	Min	Max	Min		
SSTL-2 Class I	-0.3	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.31	V <sub>REF</sub> + 0.31	V <sub>TT</sub> - 0.57	V <sub>TT</sub> + 0.57	8.1	-8.1
SSTL-2 Class II	-0.3	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.31	V <sub>REF</sub> + 0.31	V <sub>TT</sub> - 0.76	V <sub>TT</sub> + 0.76	16.2	-16.2
SSTL-18 Class I	-0.3	V <sub>REF</sub> - 0.125	V <sub>REF</sub> + 0.125	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.25	V <sub>REF</sub> + 0.25	V <sub>TT</sub> - 0.475	V <sub>TT</sub> + 0.475	6.7	-6.7
SSTL-18 Class II	-0.3	V <sub>REF</sub> - 0.125	V <sub>REF</sub> + 0.125	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.25	V <sub>REF</sub> + 0.25	0.28	V <sub>CCIO</sub> - 0.28	13.4	-13.4
SSTL-15 Class I	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.175	V <sub>REF</sub> + 0.175	0.2 × V <sub>CCIO</sub>	0.8 × V <sub>CCIO</sub>	8	-8

Table 1–33 lists the differential I/O standard specifications for Arria II GZ devices.

**Table 1–33. Differential I/O Standard Specifications for Arria II GZ Devices (Note 1)**

I/O Standard (2)	$V_{CCIO}$ (V)			$V_{ID}$ (mV)			$V_{ICM(DC)}$ (V)		$V_{OD}$ (V) (3)			$V_{OCM}$ (V) (3)		
	Min	Typ	Max	Min	Cond.	Max	Min	Max	Min	Typ	Max	Min	Typ	Max
2.5 V LVDS (HIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.05	1.8	0.247	—	0.6	1.125	1.25	1.375
2.5 V LVDS (VIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.05	1.8	0.247	—	0.6	1	1.25	1.5
RSDS (HIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.3	1.4	0.1	0.2	0.6	0.5	1.2	1.4
RSDS (VIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.3	1.4	0.1	0.2	0.6	0.5	1.2	1.5
Mini-LVDS (HIO)	2.375	2.5	2.625	200	—	600	0.4	1.32 <sub>5</sub>	0.25	—	0.6	1	1.2	1.4
Mini-LVDS (VIO)	2.375	2.5	2.625	200	—	600	0.4	1.32 <sub>5</sub>	0.25	—	0.6	1	1.2	1.5
LVPECL	2.375	2.5	2.625	300	—	—	0.6	1.8	—	—	—	—	—	—
BLVDS (4)	2.375	2.5	2.625	100	—	—	—	—	—	—	—	—	—	—

**Notes to Table 1–33:**

- (1) 1.4-V/1.5-V PCML transceiver I/O standard specifications are described in “Transceiver Performance Specifications” on page 1–21.
- (2) Vertical I/O (VIO) is top and bottom I/Os; horizontal I/O (HIO) is left and right I/Os.
- (3)  $R_L$  range:  $90 \leq RL \leq 110 \Omega$ .
- (4) There are no fixed  $V_{ICM}$ ,  $V_{OD}$ , and  $V_{OCM}$  specifications for BLVDS. These specifications depend on the system topology.

## Power Consumption for the Arria II Device Family

Altera offers two ways to estimate power for a design:

- Using the Microsoft Excel-based Early Power Estimator
- Using the Quartus® II PowerPlay Power Analyzer feature

The interactive Microsoft Excel-based Early Power Estimator is typically used prior to designing the FPGA in order to get a magnitude estimate of the device power. The Quartus II PowerPlay Power Analyzer provides better quality estimates based on the specifics of the design after place-and-route is complete. The PowerPlay Power Analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities which, when combined with detailed circuit models, can yield very accurate power estimates.

 For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in volume 3 of the *Quartus II Handbook*.

Table 1–34. Transceiver Specifications for Arria II GX Devices **(Note 1)** (Part 3 of 7)

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max										
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	—	—	125	—	—	125	—	MHz
reconfig_clk clock frequency	Dynamic reconfig. clock frequency	2.5/ 37.5 <i>(4)</i>	—	50	MHz									
Delta time between reconfig_clks <i>(5)</i>	—	—	—	2	—	—	2	—	—	2	—	—	2	ms
Transceiver block minimum power-down pulse width	—	—	1	—	—	1	—	—	1	—	—	1	—	μs
<b>Receiver</b>														
Supported I/O Standards	1.4-V PCML, 1.5-V PCML, 2.5-V PCML, 2.5-V PCML, LVPECL, and LVDS													
Data rate <i>(13)</i>	—	600	—	6375	600	—	3750	600	—	3750	600	—	3125	Mbps
Absolute V <sub>MAX</sub> for a receiver pin <i>(6)</i>	—	—	—	1.5	—	—	1.5	—	—	1.5	—	—	1.5	V
Absolute V <sub>MIN</sub> for a receiver pin	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p)	V <sub>ICM</sub> = 0.82 V setting	—	—	2.7	—	—	2.7	—	—	2.7	—	—	2.7	V
	V <sub>ICM</sub> = 1.1 V setting <i>(7)</i>	—	—	1.6	—	—	1.6	—	—	1.6	—	—	1.6	V

**Table 1–34. Transceiver Specifications for Arria II GX Devices ([Note 1](#)) (Part 7 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Digital reset pulse width	—	Minimum is 2 parallel clock cycles												

**Notes to Table 1–34:**

- (1) For AC-coupled links, the on-chip biasing circuit is switched off before and during configuration. Ensure that input specifications are not violated during this period.
- (2) The rise/fall time is specified from 20% to 80%.
- (3) To calculate the REFCLK rms phase jitter requirement at reference clock frequencies other than 100 MHz, use the following formula:  

$$\text{REFCLK rms phase jitter at } f \text{ (MHz)} = \text{REFCLK rms phase jitter at 100 MHz} * 100/f.$$
- (4) The minimum reconfig\_clk frequency is 2.5 MHz if the transceiver channel is configured in **Transmitter only** mode. The minimum reconfig\_clk frequency is 37.5 MHz if the transceiver channel is configured in **Receiver only** or **Receiver and Transmitter** mode. For more information, refer to [AN 558: Implementing Dynamic Reconfiguration in Arria II Devices](#).
- (5) If your design uses more than one dynamic reconfiguration controller instances (altgx\_reconfig) to control the transceiver channels (altgx) physically located on the same side of the device, and if you use different reconfig\_clk sources for these altgx\_reconfig instances, the delta time between any two of these reconfig\_clk sources becoming stable must not exceed the maximum specification listed.
- (6) The device cannot tolerate prolonged operation at this absolute maximum.
- (7) You must use the 1.1-V RX V<sub>ICM</sub> setting if the input serial data standard is LVDS and the link is DC-coupled.
- (8) The rate matcher supports only up to  $\pm 300$  parts per million (ppm).
- (9) Time taken to rx\_pll\_locked goes high from rx\_analogreset de-assertion. Refer to [Figure 1–1](#).
- (10) The time in which the CDR must be kept in lock-to-reference mode after rx\_pll\_locked goes high and before rx\_locktodata is asserted in manual mode. Refer to [Figure 1–1](#).
- (11) The time taken to recover valid data after the rx\_locktodata signal is asserted in manual mode. Refer to [Figure 1–1](#).
- (12) The time taken to recover valid data after the rx\_freqlocked signal goes high in automatic mode. Refer to [Figure 1–2](#).
- (13) To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.

**Table 1–35. Transceiver Specifications for Arria II GZ Devices (Part 5 of 5)**

Symbol/ Description	Conditions	–C3 and –I3 (1)			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
-3 dB Bandwidth	PCIe Gen1	2.5 - 3.5						MHz
	PCIe Gen2	6 - 8						MHz
	(OIF) CEI PHY at 4.976 Gbps	7 - 11						MHz
	(OIF) CEI PHY at 6.375 Gbps	5 - 10						MHz
	XAUl	2 - 4						MHz
	SRIO 1.25 Gbps	3 - 5.5						MHz
	SRIO 2.5 Gbps	3 - 5.5						MHz
	SRIO 3.125 Gbps	2 - 4						MHz
	GIGE	2.5 - 4.5						MHz
	SONET OC12	1.5 - 2.5						MHz
	SONET OC48	3.5 - 6						MHz
<b>Transceiver-FPGA Fabric Interface</b>								
Interface speed	—	25	—	325	25	—	250	MHz
Digital reset pulse width	—	Minimum is two parallel clock cycles					—	

**Notes to Table 1–35:**

- (1) The 3x speed grade is the fastest speed grade offered in the following Arria II GZ devices: EP2AGZ225, EP2AGZ300, and EP2AGZ350.
- (2) The rise and fall time transition is specified from 20% to 80%.
- (3) To calculate the REFCLK rms phase jitter requirement at reference clock frequencies other than 100 MHz, use the following formula:  

$$\text{REFCLK rms phase jitter at } f \text{ (MHz)} = \text{REFCLK rms phase jitter at 100 MHz} * 100/f$$
- (4) The minimum reconfig\_clk frequency is 2.5 MHz if the transceiver channel is configured in **Transmitter only** mode. The minimum reconfig\_clk frequency is 37.5 MHz if the transceiver channel is configured in **Receiver only** or **Receiver and Transmitter** mode.
- (5) If your design uses more than one dynamic reconfiguration controller (`altgx_reconfig`) instances to control the transceiver (`altgx`) channels physically located on the same side of the device AND if you use different reconfig\_clk sources for these `altgx_reconfig` instances, the delta time between any two of these reconfig\_clk sources becoming stable must not exceed the maximum specification listed.
- (6) The device cannot tolerate prolonged operation at this absolute maximum.
- (7) You must use the 1.1-V RX V<sub>ICM</sub> setting if the input serial data standard is LVDS.
- (8) The differential eye opening specification at the receiver input pins assumes that Receiver Equalization is disabled. If you enable Receiver Equalization, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level. Use H-Spice simulation to derive the minimum eye opening requirement with Receiver Equalization enabled.
- (9) The rate matcher supports only up to  $\pm 300$  ppm.
- (10) Time taken to rx\_pll\_locked goes high from rx\_analogreset de-assertion. Refer to [Figure 1–1 on page 1–33](#).
- (11) Time for which the CDR must be kept in lock-to-reference mode after rx\_pll\_locked goes high and before rx\_locktodata is asserted in manual mode. Refer to [Figure 1–1 on page 1–33](#).
- (12) Time taken to recover valid data after the rx\_locktodata signal is asserted in manual mode. Refer to [Figure 1–1 on page 1–33](#).
- (13) Time taken to recover valid data after the rx\_freqlocked signal goes high in automatic mode. Refer to [Figure 1–2 on page 1–33](#).
- (14) A GPLL may be required to meet the PMA-FPGA fabric interface timing above certain data rates. For more information, refer to the [Transceiver Clocking for Arria II Devices](#) chapter.
- (15) The Quartus II software automatically selects the appropriate slew rate depending on the configured data rate or functional mode.
- (16) To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (Note 1) (Part 3 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max										
<b>PCIe Receiver Jitter Tolerance (4)</b>														
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	> 0.6			> 0.6			> 0.6			> 0.6			UI
<b>PCIe (Gen 1) Electrical Idle Detect Threshold (9)</b>														
VRX-IDLE-DETDIFF (p-p)	Compliance pattern	65	—	175	65	—	175	65	—	175	65	—	175	mV
<b>Serial RapidIO® (SRIO) Transmit Jitter Generation (5)</b>														
Deterministic jitter (peak-to-peak)	Data Rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.17	—	—	0.17	—	—	0.17	—	—	0.17	UI
Total jitter (peak-to-peak)	Data Rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
<b>SRIO Receiver Jitter Tolerance (5)</b>														
Deterministic jitter tolerance (peak-to-peak)	Data Rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.37			> 0.37			> 0.37			> 0.37			UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Data Rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.55			> 0.55			> 0.55			> 0.55			UI
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 22.1 KHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 8.5			> 8.5			> 8.5			> 8.5			UI
	Jitter frequency = 1.875 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1			> 0.1			> 0.1			> 0.1			UI
	Jitter frequency = 20 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1			> 0.1			> 0.1			> 0.1			UI
<b>GIGE Transmit Jitter Generation (6)</b>														
Deterministic jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.14	—	—	0.14	—	—	0.14	—	—	0.14	UI

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 10 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Sinusoidal jitter tolerance at 3072 Mbps	Jitter frequency = 21.8 KHz Pattern = CJPAT	> 8.5			> 8.5			> 8.5			> 8.5			UI
	Jitter frequency = 1843.2 KHz to 20 MHz Pattern = CJPAT	> 0.1			> 0.1			> 0.1			> 0.1			UI

**Notes to Table 1–40:**

- (1) Dedicated `refclk` pins are used to drive the input reference clocks. The jitter numbers are valid for the stated conditions only.
- (2) The jitter numbers for SONET/SDH are compliant to the GR-253-CORE Issue 3 Specification.
- (3) The jitter numbers for XAUI are compliant to the IEEE802.3ae-2002 Specification.
- (4) The jitter numbers for PCIe are compliant to the PCIe Base Specification 2.0.
- (5) The jitter numbers for SRIO are compliant to the RapidIO Specification 1.3.
- (6) The jitter numbers for GIGE are compliant to the IEEE802.3-2002 Specification.
- (7) The jitter numbers for HiGig are compliant to the IEEE802.3ae-2002 Specification.
- (8) The HD-SDI and 3G-SDI jitter numbers are compliant to the SMPTE292M and SMPTE424M Specifications.
- (9) Arria II PCIe receivers are compliant to this specification provided the `VTX_CM-DC-ACTIVEIDLE-DELTA` of the upstream transmitter is less than 50 mV.
- (10) The jitter numbers for Serial Advanced Technology Attachment (SATA) are compliant to the Serial ATA Revision 3.0 Specification.
- (11) The jitter numbers for Common Public Radio Interface (CPRI) are compliant to the CPRI Specification V3.0.
- (12) The jitter numbers for Open Base Station Architecture Initiative (OBSAI) are compliant to the OBSAI RP3 Specification V4.1.

Table 1–41 lists the transceiver jitter specifications for all supported protocols for Arria II GZ devices.

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (*Note 1*), (*2*) (Part 1 of 7)**

Symbol/ Description	Conditions	-C3 and -I3			-C4 and -I4			Unit
		Min	Typ	Max	Min	Typ	Max	
<b>SONET/SDH Transmit Jitter Generation (<i>3</i>)</b>								
Peak-to-peak jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	UI
RMS jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	UI
Peak-to-peak jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	UI
RMS jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	UI
<b>SONET/SDH Receiver Jitter Tolerance (<i>3</i>)</b>								
Jitter tolerance at 622.08 Mbps	Jitter frequency = 0.03 KHz Pattern = PRBS15	> 15			> 15			UI
	Jitter frequency = 25 KHz Pattern = PRBS15	> 1.5			> 1.5			UI
	Jitter frequency = 250 KHz Pattern = PRBS15	> 0.15			> 0.15			UI

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 3 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
Peak-to-peak jitter	Jitter frequency = 22.1 KHz	> 8.5			> 8.5			UI
Peak-to-peak jitter	Jitter frequency = 1.875 MHz	> 0.1			> 0.1			UI
Peak-to-peak jitter	Jitter frequency = 20 MHz	> 0.1			> 0.1			UI
<b>PCIe Transmit Jitter Generation (8)</b>								
Total jitter at 2.5 Gbps (Gen1)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	0.25	UI
Total jitter at 5 Gbps (Gen2)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	—	UI
<b>PCIe Receiver Jitter Tolerance (8)</b>								
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	> 0.6			> 0.6			UI
Total jitter at 5 Gbps (Gen2)	Compliance pattern	Not supported			Not supported			UI
<b>PCIe (Gen 1) Electrical Idle Detect Threshold</b>								
V <sub>RX-IDLE-DETDIFFp-p</sub> (9)	Compliance pattern	65	—	175	65	—	175	UI
<b>SRIO Transmit Jitter Generation (10)</b>								
Deterministic jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.17	—	—	0.17	UI
Total jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.35	—	—	0.35	UI
<b>SRIO Receiver Jitter Tolerance (10)</b>								
Deterministic jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.37			> 0.37			UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.55			> 0.55			UI
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 22.1 KHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 8.5			> 8.5			UI
	Jitter frequency = 1.875 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1			> 0.1			UI
	Jitter frequency = 20 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1			> 0.1			UI
<b>GIGE Transmit Jitter Generation (11)</b>								
Deterministic jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.14	—	—	0.14	UI
Total jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.279	—	—	0.279	UI

## Core Performance Specifications for the Arria II Device Family

This section describes the clock tree, phase-locked loop (PLL), digital signal processing (DSP), embedded memory, configuration, and JTAG specifications for Arria II GX and GZ devices.

### Clock Tree Specifications

Table 1–42 lists the clock tree specifications for Arria II GX devices.

**Table 1–42. Clock Tree Performance for Arria II GX Devices**

Clock Network	Performance			Unit
	I3, C4	C5,I5	C6	
GCLK and RCLK	500	500	400	MHz
PCLK	420	350	280	MHz

Table 1–43 lists the clock tree specifications for Arria II GZ devices.

**Table 1–43. Clock Tree Performance for Arria II GZ Devices**

Clock Network	Performance		Unit
	-C3 and -I3	-C4 and -I4	
GCLK and RCLK	700	500	MHz
PCLK	500	450	MHz

### PLL Specifications

Table 1–44 lists the PLL specifications for Arria II GX devices.

**Table 1–44. PLL Specifications for Arria II GX Devices (Part 1 of 3)**

Symbol	Description	Min	Typ	Max	Unit
$f_{IN}$	Input clock frequency (from clock input pins residing in right/top/bottom banks) (-4 Speed Grade)	5	—	670 (1)	MHz
	Input clock frequency (from clock input pins residing in right/top/bottom banks) (-5 Speed Grade)	5	—	622 (1)	MHz
	Input clock frequency (from clock input pins residing in right/top/bottom banks) (-6 Speed Grade)	5	—	500 (1)	MHz
$f_{INPFD}$	Input frequency to the PFD	5	—	325	MHz
$f_{VCO}$	PLL VCO operating Range (2)	600	—	1,400	MHz
$f_{INDUTY}$	Input clock duty cycle	40	—	60	%
$f_{EINDUTY}$	External feedback clock input duty cycle	40	—	60	%
$t_{INCCJ}$ (3), (4)	Input clock cycle-to-cycle jitter (Frequency $\geq$ 100 MHz)	—	—	0.15	UI (p–p)
	Input clock cycle-to-cycle jitter (Frequency $\leq$ 100 MHz)	—	—	$\pm 750$	ps (p–p)

**Table 1–44. PLL Specifications for Arria II GX Devices (Part 2 of 3)**

<b>Symbol</b>	<b>Description</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$f_{\text{OUT}}$	Output frequency for internal global or regional clock (-4 Speed Grade)	—	—	500	MHz
	Output frequency for internal global or regional clock (-5 Speed Grade)	—	—	500	MHz
	Output frequency for internal global or regional clock (-6 Speed Grade)	—	—	400	MHz
$f_{\text{OUT\_EXT}}$	Output frequency for external clock output (-4 Speed Grade)	—	—	670 (5)	MHz
	Output frequency for external clock output (-5 Speed Grade)	—	—	622 (5)	MHz
	Output frequency for external clock output (-6 Speed Grade)	—	—	500 (5)	MHz
$t_{\text{OUTDUTY}}$	Duty cycle for external clock output (when set to 50%)	45	50	55	%
$t_{\text{OUTPJ\_DC}}$	Dedicated clock output period jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	300	ps (p-p)
	Dedicated clock output period jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	30	mUI (p-p)
$t_{\text{OUTCCJ\_DC}}$	Dedicated clock output cycle-to-cycle jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	300	ps (p-p)
	Dedicated clock output cycle-to-cycle jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	30	mUI (p-p)
$f_{\text{OUTPJ\_IO}}$	Regular I/O clock output period jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	650	ps (p-p)
	Regular I/O clock output period jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	65	mUI (p-p)
$f_{\text{OUTCCJ\_IO}}$	Regular I/O clock output cycle-to-cycle jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	650	ps (p-p)
	Regular I/O clock output cycle-to-cycle jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	65	mUI (p-p)
$t_{\text{CONFIGPLL}}$	Time required to reconfigure PLL scan chains	—	3.5	—	SCANCLK cycles
$t_{\text{CONFIGPHASE}}$	Time required to reconfigure phase shift	—	1	—	SCANCLK cycles
$f_{\text{SCANCLK}}$	SCANCLK frequency	—	—	100	MHz
$t_{\text{LOCK}}$	Time required to lock from end of device configuration	—	—	1	ms
$t_{\text{DLLOCK}}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	1	ms
$f_{\text{CLBW}}$	PLL closed-loop low bandwidth	—	0.3	—	MHz
	PLL closed-loop medium bandwidth	—	1.5	—	MHz
	PLL closed-loop high bandwidth	—	4	—	MHz
$t_{\text{PLL\_PSERR}}$	Accuracy of PLL phase shift	—	—	$\pm 50$	ps
$t_{\text{ARESET}}$	Minimum pulse width on areset signal	10	—	—	ns

## DSP Block Specifications

Table 1–46 lists the DSP block performance specifications for Arria II GX devices.

**Table 1–46. DSP Block Performance Specifications for Arria II GX Devices (Note 1)**

Mode	Resources Used	Performance				Unit
	Number of Multipliers	C4	I3	C5,I5	C6	
9 × 9-bit multiplier	1	380	310	300	250	MHz
12 × 12-bit multiplier	1	380	310	300	250	MHz
18 × 18-bit multiplier	1	380	310	300	250	MHz
36 × 36-bit multiplier	1	350	270	270	220	MHz
18 × 36-bit high-precision multiplier adder mode	1	350	270	270	220	MHz
18 × 18-bit multiply accumulator	4	380	310	300	250	MHz
18 × 18-bit multiply adder	4	380	310	300	250	MHz
18 × 18-bit multiply adder-signed full precision	2	380	310	300	250	MHz
18 × 18-bit multiply adder with loopback (2)	2	275	220	220	180	MHz
36-bit shift (32-bit data)	1	350	270	270	220	MHz
Double mode	1	350	270	270	220	MHz

**Notes to Table 1–46:**

- (1) Maximum is for a fully-pipelined block with **Round** and **Saturation** disabled.
- (2) Maximum is for loopback input registers disabled, **Round** and **Saturation** disabled, pipeline and output registers enabled.

Table 1–47 lists the DSP block performance specifications for Arria II GZ devices.

**Table 1–47. DSP Block Performance Specifications for Arria II GZ Devices (Note 1) (Part 1 of 2)**

Mode	Resources Used	Performance		Unit
	Number of Multipliers	-3	-4	
9 × 9-bit multiplier	1	460	400	MHz
12 × 12-bit multiplier	1	500	440	MHz
18 × 18-bit multiplier	1	550	480	MHz
36 × 36-bit multiplier	1	440	380	MHz
18 × 18-bit multiply accumulator	4	440	380	MHz
18 × 18-bit multiply adder	4	470	410	MHz
18 × 18-bit multiply adder-signed full precision	2	450	390	MHz
18 × 18-bit multiply adder with loopback (2)	2	350	310	MHz
36-bit shift (32-bit data)	1	440	380	MHz

Table 1–49 lists the embedded memory block specifications for Arria II GZ devices.

**Table 1–49. Embedded Memory Block Performance Specifications for Arria II GZ Devices (Note 1)**

Memory	Mode	Resources Used		Performance			Unit
		ALUTs	TriMatrix Memory	C3	I3	C4	
MLAB (2)	Single port 64 × 10	0	1	500	500	450	450 MHz
	Simple dual-port 32 × 20	0	1	500	500	450	450 MHz
	Simple dual-port 64 × 10	0	1	500	500	450	450 MHz
	ROM 64 × 10	0	1	500	500	450	450 MHz
	ROM 32 × 20	0	1	500	500	450	450 MHz
M9K Block (2)	Single-port 256 × 36	0	1	540	540	475	475 MHz
	Simple dual-port 256 × 36	0	1	490	490	420	420 MHz
	Simple dual-port 256 × 36, with the read-during-write option set to <b>Old Data</b>	0	1	340	340	300	300 MHz
	True dual port 512 × 18	0	1	430	430	370	370 MHz
	True dual-port 512 × 18, with the read-during-write option set to <b>Old Data</b>	0	1	335	335	290	290 MHz
	ROM 1 Port	0	1	540	540	475	475 MHz
	ROM 2 Port	0	1	540	540	475	475 MHz
	Min Pulse Width (clock high time)	—	—	800	800	850	850 ps
M144K Block (2)	Min Pulse Width (clock low time)	—	—	625	625	690	690 ps
	Single-port 2K × 72	0	1	440	400	380	350 MHz
	Simple dual-port 2K × 72	0	1	435	375	385	325 MHz
	Simple dual-port 2K × 72, with the read-during-write option set to <b>Old Data</b>	0	1	240	225	205	200 MHz
	Simple dual-port 2K × 64 (with ECC)	0	1	300	295	255	250 MHz
	True dual-port 4K × 36	0	1	375	350	330	310 MHz
	True dual-port 4K × 36, with the read-during-write option set to <b>Old Data</b>	0	1	230	225	205	200 MHz
	ROM 1 Port	0	1	500	450	435	420 MHz
	ROM 2 Port	0	1	465	425	400	400 MHz
	Min Pulse Width (clock high time)	—	—	755	860	860	950 ps
	Min Pulse Width (clock low time)	—	—	625	690	690	690 ps

**Notes to Table 1–48:**

- (1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to 50% output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.
- (2) When you use the error detection CRC feature, there is no degradation in  $F_{MAX}$ .

## Configuration

Table 1–50 lists the configuration mode specifications for Arria II GX and GZ devices.

**Table 1–50. Configuration Mode Specifications for Arria II Devices**

<b>Programming Mode</b>	<b>DCLK Frequency</b>			<b>Unit</b>
	<b>Min</b>	<b>Typ</b>	<b>Max</b>	
Passive serial	—	—	125	MHz
Fast passive parallel	—	—	125	MHz
Fast active serial (fast clock)	17	26	40	MHz
Fast active serial (slow clock)	8.5	13	20	MHz
Remote update only in fast AS mode	—	—	10	MHz

## JTAG Specifications

Table 1–51 lists the JTAG timing parameters and values for Arria II GX and GZ devices.

**Table 1–51. JTAG Timing Parameters and Values for Arria II Devices**

<b>Symbol</b>	<b>Description</b>	<b>Min</b>	<b>Max</b>	<b>Unit</b>
$t_{JCP}$	TCK clock period	30	—	ns
$t_{JCH}$	TCK clock high time	14	—	ns
$t_{JCL}$	TCK clock low time	14	—	ns
$t_{JPSU}$ (TDI)	TDI JTAG port setup time	1	—	ns
$t_{JPSU}$ (TMS)	TMS JTAG port setup time	3	—	ns
$t_{JPH}$	JTAG port hold time	5	—	ns
$t_{JPCO}$	JTAG port clock to output	—	11	ns
$t_{JPZX}$	JTAG port high impedance to valid output	—	14	ns
$t_{JPXZ}$	JTAG port valid output to high impedance	—	14	ns

## Chip-Wide Reset (Dev\_CLRn) Specifications

Table 1–52 lists the specifications for the chip-wide reset (Dev\_CLRn) for Arria II GX and GZ devices.

**Table 1–52. Chip-Wide Reset (Dev\_CLRn) Specifications for Arria II Devices**

<b>Description</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
Dev_CLRn	500	—	—	μs

**Table 1–68. Glossary (Part 2 of 4)**

Letter	Subject	Definitions
G, H, I, J	J JTAG Timing Specifications	<p>High-speed I/O block: Deserialization factor (width of parallel data bus).</p> <p>JTAG Timing Specifications:</p> <p>The diagram illustrates the timing sequence for JTAG operations. It shows four signals: TMS, TDI, TCK, and TDO. TMS and TDI are data inputs. TCK is the clock signal. TDO is the data output. Various timing parameters are defined between these signals, such as t<sub>JCP</sub>, t<sub>JCH</sub>, t<sub>JCL</sub>, t<sub>JPSU</sub>, t<sub>JPH</sub>, t<sub>JPZX</sub>, t<sub>JPCO</sub>, and t<sub>JPXZ</sub>.</p>
K, L, M, N, O, P	PLL Specifications	<p>PLL Specification parameters:</p> <p><b>Diagram of PLL Specifications (1)</b></p> <p>The diagram shows a detailed block diagram of a PLL. It includes a Core Clock input, a Synchronizer, a Phase Frequency Detector (PFD), a Charge Pump (CP), a Loop Filter (LF), a Voltage Controlled Oscillator (VCO), a VCO post-scale counter K (with a value of 2), a Counter CO.C9, and various output paths for CLKOUT pins, GCLK, and RCLK. A feedback path from the output is labeled "External Feedback". A key legend indicates that blue boxes represent "Reconfigurable in User Mode".</p> <p><b>Notes:</b></p> <ul style="list-style-type: none"> <li>(1) CoreClock can only be fed by dedicated clock input pins or PLL outputs.</li> <li>(2) This is the VCO post-scale counter K.</li> </ul>
Q, R	R <sub>L</sub>	Receiver differential input discrete resistor (external to the Arria II device).

**Table 1–69. Document Revision History (Part 2 of 2)**

Date	Version	Changes
December 2010	4.0	<ul style="list-style-type: none"> <li>■ Added Arria II GZ information.</li> <li>■ Added Table 1–61 with Arria II GX information.</li> <li>■ Updated Table 1–1, Table 1–2, Table 1–5, Table 1–6, Table 1–7, Table 1–11, Table 1–35, Table 1–37, Table 1–40, Table 1–42, Table 1–44, Table 1–45, Table 1–57, Table 1–61, and Table 1–63.</li> <li>■ Updated Figure 1–5.</li> <li>■ Updated for the Quartus II version 10.0 release.</li> <li>■ Updated the first paragraph for searchability.</li> <li>■ Minor text edits.</li> </ul>
July 2010	3.0	<ul style="list-style-type: none"> <li>■ Updated Table 1–1, Table 1–4, Table 1–16, Table 1–19, Table 1–21, Table 1–23, Table 1–25, Table 1–26, Table 1–30, and Table 1–35</li> <li>■ Added Table 1–27 and Table 1–29.</li> <li>■ Added I3 speed grade information to Table 1–19, Table 1–21, Table 1–22, Table 1–24, Table 1–25, Table 1–30, Table 1–32, Table 1–33, Table 1–34, and Table 1–35.</li> <li>■ Updated the “Operating Conditions” section.</li> <li>■ Removed “Preliminary” from Table 1–19, Table 1–21, Table 1–22, Table 1–23, Table 1–24, Table 1–25, Table 1–26, Table 1–28, Table 1–30, Table 1–32, Table 1–33, Table 1–34, and Figure 1–4.</li> <li>■ Minor text edits.</li> </ul>
March 2010	2.3	<p>Updated for the Quartus II version 9.1 SP2 release:</p> <ul style="list-style-type: none"> <li>■ Updated Table 1–3, Table 1–7, Table 1–19, Table 1–21, Table 1–22, Table 1–24, Table 1–25 and Table 1–33.</li> <li>■ Updated “Recommended Operating Conditions” section.</li> <li>■ Minor text edits.</li> </ul>
February 2010	2.2	Updated Table 1–19.
February 2010	2.1	<p>Updated for Arria II GX v9.1 SP1 release:</p> <ul style="list-style-type: none"> <li>■ Updated Table 1–19, Table 1–23, Table 1–28, Table 1–30, and Table 1–33.</li> <li>■ Added Figure 1–5.</li> <li>■ Minor text edits.</li> </ul>
November 2009	2.0	<p>Updated for Arria II GX v9.1 release:</p> <ul style="list-style-type: none"> <li>■ Updated Table 1–1, Table 1–4, Table 1–13, Table 1–14, Table 1–19, Table 1–15, Table 1–22, Table 1–24, and Table 1–28.</li> <li>■ Added Table 1–6 and Table 1–33.</li> <li>■ Added “Bus Hold” on page 1–5.</li> <li>■ Added “IOE Programmable Delay” section.</li> <li>■ Minor text edit.</li> </ul>
June 2009	1.2	<ul style="list-style-type: none"> <li>■ Updated Table 1–1, Table 1–3, Table 1–7, Table 1–8, Table 1–18, Table 1–23, Table 1–25, Table 1–26, Table 1–29, Table 1–30, Table 1–31, Table 1–32, and Table 1–33.</li> <li>■ Added Table 1–32.</li> <li>■ Updated Equation 1–1.</li> </ul>
March 2009	1.1	Added “I/O Timing” section.
February 2009	1.0	Initial release.